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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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120V NPN DARLINGTON TRANSISTOR IN SOT223

Features

- BV_{CEO} > 120V
- BV_{CBO} > 140V
- I_C = 1.5A High Continuous Current
- hFE > 2k for High Gain @ 1A
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT223
- Case Material: Molded Plastic. "Green" Molding Compound;
 UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (§3)
- Weight: 0.112 grams (Approximate)

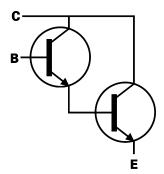
Applications

- Lamp
- Relay
- Solenoid Driving

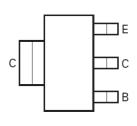




Top View



Device Symbol



Top View Pin-Out

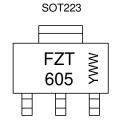
Ordering Information (Note 4)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
FZT605TA	FZT605	7	12	1,000
FZT605TC	FZT605	13	12	4,000

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/qual/ity/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http"//www.diodes.com/products/packages.html.

Marking Information



FZT 605 = Product Type Marking Code YWW = Date Code Marking Y or \overline{Y} = Last Digit of Year (ex: 5= 2015) WW or $\overline{W}W$ = Week Code (01~53)



Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	140	V
Collector-Emitter Voltage	$V_{\sf CEO}$	120	V
Emitter-Base Voltage	V_{EBO}	14	V
Continuous Collector Current	Ic	1.5	Α
Peak Pulse Current	I _{CM}	4	Α

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
	(Note 5)		3.0		
Power Dissipation	(Note 6)	P _D	2.0	W	
Power Dissipation	(Note 7)		1.6		
	(Note 8)		1.2	ı	
	(Note 5)		41.7		
Thermal Decistance, Junetian to Ambient	(Note 6)	$R_{ hetaJA}$	62.5		
Thermal Resistance, Junction to Ambient	(Note 7)		78.1	°C/W	
	(Note 8)		104	ı	
Thermal Resistance Junction to Lead (Note 9)		$R_{ hetaJL}$	12.9		
Operating and Storage Temperature Range	T_{J}, T_{STG}	-55 to +150	°C		

ESD Ratings (Note 10)

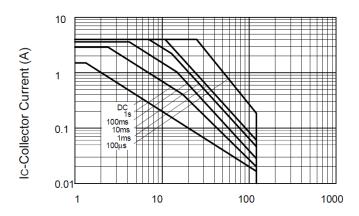
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Notes:

- 5. For a device mounted with the collector lead on 50mm x 50mm 2oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.
- 6. Same as Note 5, except the device is mounted on 25mm x 25mm 2oz copper.
- 7. Same as Note 5, except the device is mounted on 25mm x 25mm 1oz copper.
- 8. Same as Note 5, except the device is mounted on minimum recommended pad layout.
- Thermal resistance from junction to solder-point (at the end of the collector lead).
 Refer to JEDEC specification JESD22-A114 and JESD22-A115.

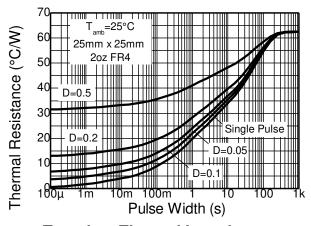


Thermal Characteristics and Derating Information

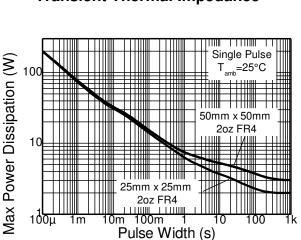


VCE - Collector Emitter Voltage (V)

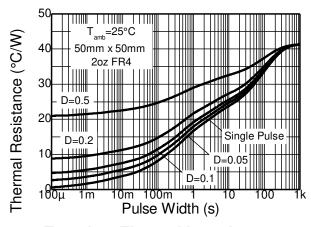
FZT605 Safe Operating Area



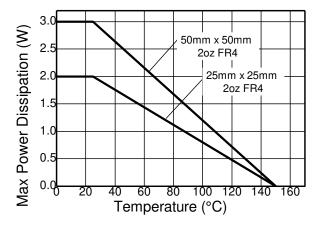
Transient Thermal Impedance



Pulse Power Dissipation



Transient Thermal Impedance



Derating Curve





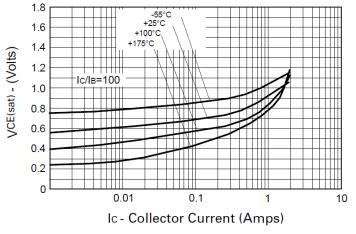
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

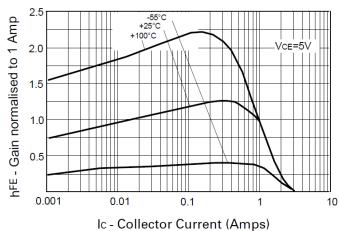
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	140	-	-	٧	$I_C = 100\mu A$
Collector-Emitter Breakdown Voltage (Note 11)	BV _{CEO}	120	_	_	V	I _C = 1mA
Emitter-Base Breakdown Voltage	BV _{EBO}	14	_	_	V	$I_E = 100\mu A$
Collector-Base Cut-Off Current	I _{CBO}	-	_	100 10	nA μA	V _{CB} = 120V V _{CB} = 120V, T _A = +120°C
Collector-Emitter Cut-Off Current	I _{CES}	-	_	100	nA	V _{CE} = 120V
Emitter Cut-Off Current	I _{EBO}	-	_	100	nA	V _{EB} = 8V
DC Current Gain (Note 11)	h _{FE}	2,000 5,000 2,000 500	1111	_ _ 100,000 _	ı	$\begin{split} I_{C} &= 50 \text{mA}, \ V_{CE} = 5 \text{V} \\ I_{C} &= 500 \text{mA}, \ V_{CE} = 5 \text{V} \\ I_{C} &= 1 \text{A}, \ V_{CE} = 5 \text{V} \\ I_{C} &= 2 \text{A}, \ V_{CE} = 5 \text{V} \end{split}$
Collector-Emitter Saturation Voltage (Note 11)	V _{CE(sat)}			1 1.5	V	$I_C = 250$ mA, $I_B = 0.25$ mA $I_C = 1$ A, $I_B = 1$ mA
Base-Emitter Saturation Voltage (Note 11)	V _{BE(sat)}	_	_	1.8	V	I _C = 1A, I _B = 1mA
Base-Emitter Turn-On Voltage (Note 11)	V _{BE(on)}	_	_	1.7	V	I _C = 1A, V _{CE} = 5V
Input Capacitance	C _{ibo}	_	90	_	pF	V _{EB} = 0.5V, f = 1MHz
Output Capacitance	C _{obo}	_	15	_	pF	$V_{CB} = 10V$, $f = 1MHz$
Current Gain-Bandwidth Product	f _T	150	_	_	MHz	V _{CE} = 10V, I _C = 100mA, f=20MHz
Turn-On Time	ton	_	0.5	_	μs	V _{CC} = 10V, I _C = 500mA
Turn-Off Time	t _{off}	_	1.6	_	μs	$I_{B1} = -I_{B2} = 0.5 \text{mA}$

Note: 11. Measured under pulsed conditions. Pulse width \leq 300 μ s. Duty cycle \leq 2%.



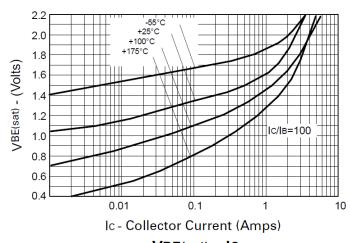
Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

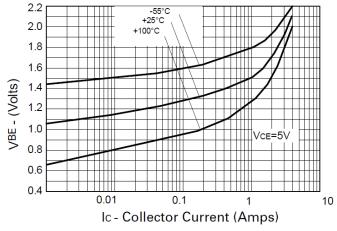




VCE(sat) v IC

hFE v IC



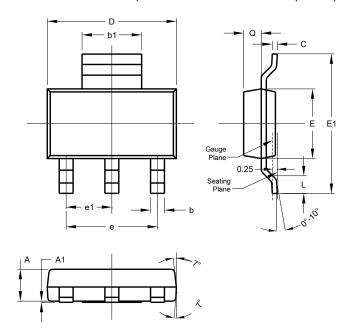


VBE(on) v IC



Package Outline Dimensions

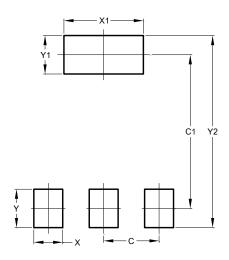
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOT223					
Dim	Min	Max	Тур		
Α	1.55	1.65	1.60		
A 1	0.010	0.15	0.05		
b	0.60	0.80	0.70		
b1	2.90	3.10	3.00		
С	0.20	0.30	0.25		
D	6.45	6.55	6.50		
Е	3.45	3.55	3.50		
E1	6.90	7.10	7.00		
е	-	-	4.60		
e1	-	-	2.30		
L	0.85	1.05	0.95		
Q	0.84	0.94	0.89		
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)		
С	2.30		
C1	6.40		
Х	1.20		
X1	3.30		
Υ	1.60		
Y 1	1.60		
Y2	8.00		

For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device terminals and PCB tracking.





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